

## Tentative

## CM150DU-24NFH

Pre.	M.Koura	Rev	A	M. KOURA
Apr.	M.Tabata 21-Nov.'02			M. Tabata 9-Apr.'03

HIGH POWER SWITCHING USE

Notice : This is not a final specification. Some parametric limits are subject to change.

CM150DU-24NFH

- $I_c$ .....150A
- $V_{CES}$ .....1200V
- Insulated Type
- 2-elements in a pack

## APPLICATION

High frequency switching use (30kHz to 60kHz).  
Gradient amplifier, Induction heating, power supply, etc.

ABSOLUTE MAXIMUM RATINGS ( $T_j = 25\text{ }^\circ\text{C}$ )

Symbol	Item	Conditions	Ratings	Units
$V_{CES}$	Collector-emitter voltage	G-E Short	1200	V
$V_{GES}$	Gate-emitter voltage	C-E Short	$\pm 20$	V
$I_c$	Collector current	$T_c = 25\text{ }^\circ\text{C}$	150	A
$I_{CM}$		Pulse (2)	300	
$I_E$ (1)	Emitter current	$T_c = 25\text{ }^\circ\text{C}$	150	A
$I_{EM}$ (1)		Pulse (2)	300	
$P_C$ (3)	Maximum collector dissipation	$T_c = 25\text{ }^\circ\text{C}$	650	W
$P_C$ (3)	Maximum collector dissipation	$T_c' = 25\text{ }^\circ\text{C}^*$	960	
$T_j$	Junction temperature		$-40 \sim +150$	$^\circ\text{C}$
$T_{stg}$	Storage temperature		$-40 \sim +125$	$^\circ\text{C}$
Viso	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
—	Torque strength	Main terminal M5	2.5 ~ 3.5	N·m
—	Torque strength	Mounting holes M6	3.5 ~ 4.5	N·m
—	Weight	Typical value	310	g

ELECTRICAL CHARACTERISTICS ( $T_j = 25^\circ\text{C}$ )

Symbol	Item	Conditions	Min.	Typ.	Max.	Units	
$I_{CES}$	Collector cutoff current	$V_{CE}=V_{CES}, V_{GE}=0V$	—	—	1	mA	
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C=15mA, V_{CE}=10V$	5	6	7	V	
$I_{GES}$	Gate leakage current	$V_{GE}=V_{GES}, V_{CE}=0V$	—	—	0.5	$\mu A$	
$V_{CE(sat)}$	Collector to emitter saturation voltage ④	$T_j=25^\circ\text{C}$ $I_C=150A$	—	5.0	6.5	V	A
		$T_j=125^\circ\text{C}$ $V_{GE}=15V$	—	5.0	—		
$C_{ies}$	Input capacitance	$V_{CE}=10V$	—	—	24	nF	
$C_{oes}$	Output capacitance	$V_{GE}=0V$	—	—	2.0		
$C_{res}$	Reverse transfer capacitance		—	—	0.45		
$Q_G$	Total gate charge	$V_{CC}=600V, I_C=150A, V_{GE}=15V$	—	680	—	nC	
$t_d(on)$	Turn-on delay time	$V_{CC}=600V, I_C=150A$	—	—	150	ns	A
$t_r$	Turn-on rise time	$V_{GE1}=V_{GE2}=15V$	—	—	80		
$t_d(off)$	Turn-off delay time	$R_G=2.1\Omega$ , Inductive load	—	—	400		
$t_f$	Turn-off fall time	switching operation	—	—	150		
$t_{rr}$ ①	Reverse recovery time	$I_E=150A$	—	—	150	ns	A
$Q_{rr}$ ①	Reverse recovery charge		—	7.5	—	$\mu C$	
$V_{EC}$ ①	Emitter-collector voltage	$I_E=150A, V_{GE}=0V$	—	—	3.5	V	
$R_{th(j-c)Q}$	Thermal resistance	IGBT part (1/2 module)	—	—	0.19	$^\circ\text{C/W}$	A
$R_{th(j-c)R}$		FWDi part(1/2 module)	—	—	0.35		
$R_{th(c-f)}$	Contact thermal resistance	Case to fin, Thermal compound Applied (1/2module) *2	—	0.07	—		
$R_{th(j-c')Q}$	Thermal resistance *4	IGBT part (1/2 module)	—	—	0.13*3		
$R_{th(j-c')R}$		FWDi part(1/2 module)	—	—	0.21*3		
$R_G$	External gate resistance		2.1	—	21	$\Omega$	

\*1:  $T_c$  measured point is shown in page OUTLINE DRAWING.

\*2: Typical value is measured by using Shin-etsu Silicone "G-746".

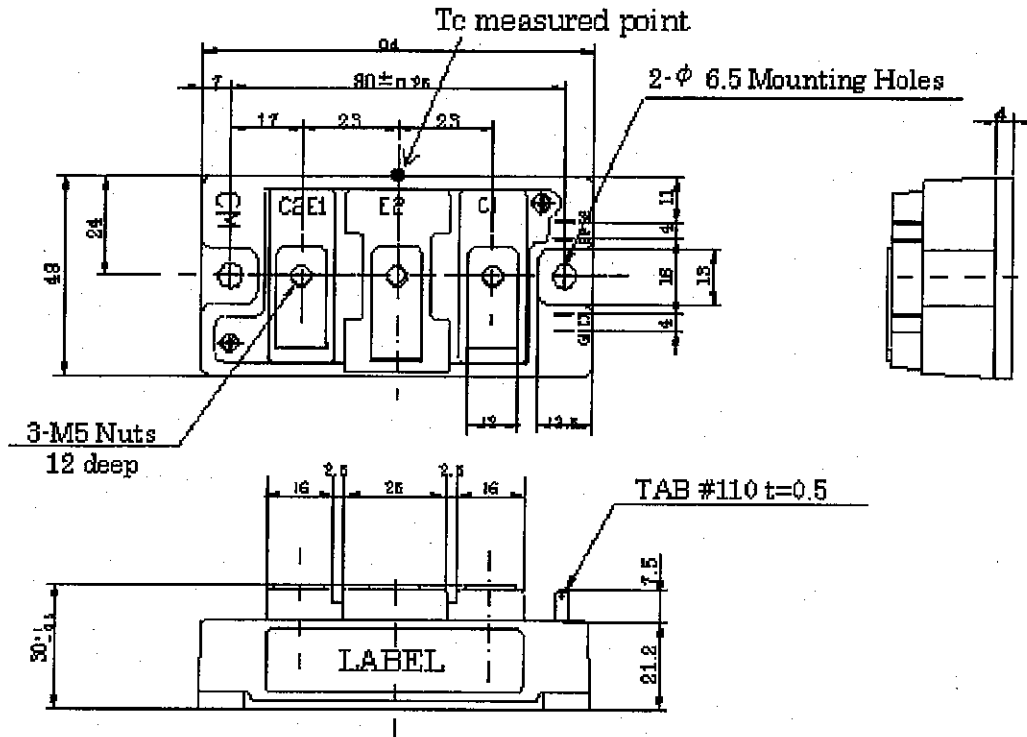
\*3: If you use this value,  $R_{th(f-a)}$  should be measured just under the chips.

\*4:  $T_c$  measured point is just under the chips.

- ①  $I_E, V_{EC}, t_{rr}, Q_{rr}$  & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
- ② Pulse width and repetition rate should be such that the device junction temp. ( $T_j$ ) dose not exceed  $T_{jmax}$  rating.
- ③ Junction temperature ( $T_j$ ) should not increase beyond  $150^\circ\text{C}$ .
- ④ Pulse width and repetition rate should be such as to cause neglible temperature rise.
- ⑤ No short circuit capability is designed.

OUTLINE DRAWING

Dimensions in mm



CIRCUIT DIAGRAM

